

BFP620

Surface mount high linearity silicon NPN RF bipolar transistor



Order now



Technical documents



Simulation



Support

Product description

The BFP620 is a RF bipolar transistor based on SiGe:C technology that is part of Infineon's established sixth generation transistor family. Its high linearity characteristics and collector design make the device suitable for a wide range of wireless applications. It remains cost competitive without compromising on ease of use.



Feature list

- Minimum noise figure $NF_{min} = 0.7$ dB at 1.8 GHz, 1.5 V, 5 mA
- High gain $G_{ms} = 21.5$ dB at 1.8 GHz, 1.5 V, 50 mA
- $OIP_3 = 25.5$ dBm at 1.8 GHz, 2 V, 50 mA

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Potential applications

- Low noise amplifiers (LNAs) in SDARS receivers
- LNAs for wireless communications
- LNAs for ISM band applications

Device information

Table 1 Part information

| Product name / Ordering code | Package | Pin configuration | | | | Marking | Pieces / Reel |
|------------------------------|---------|-------------------|-------|-------|-------|---------|---------------|
| BFP620 / BFP620H7764XTSA1 | SOT343 | 1 = B | 2 = E | 3 = C | 4 = E | R2s | 3000 |

Attention: *ESD (Electrostatic discharge) sensitive device, observe handling precautions*

Table of contents**Table of contents**

| | |
|--|----|
| Product description | 1 |
| Feature list | 1 |
| Product validation | 1 |
| Potential applications | 1 |
| Device information | 1 |
| Table of contents | 2 |
| 1 Absolute maximum ratings | 3 |
| 2 Thermal characteristics | 4 |
| 3 Electrical characteristics | 6 |
| 3.1 DC characteristics | 6 |
| 3.2 General AC characteristics | 6 |
| 3.3 Frequency dependent AC characteristics | 7 |
| 3.4 Characteristic AC diagrams | 8 |
| 4 Package information SOT343 | 13 |
| Revision history | 14 |
| Disclaimer | 15 |

Absolute maximum ratings**1 Absolute maximum ratings****Table 2 Absolute maximum ratings at $T_A = 25^\circ\text{C}$ (unless otherwise specified)**

| Parameter | Symbol | Values | | Unit | Note or test condition |
|---------------------------------------|-----------|--------|------|-----------------------------|---------------------------------------|
| | | Min. | Max. | | |
| Collector emitter voltage | V_{CEO} | - | 2.3 | V | Open base |
| | | | 2.1 | | $T_A = -55^\circ\text{C}$, open base |
| Collector emitter voltage | | | 7.5 | | E-B short circuited |
| Collector base voltage | | | 7.5 | | Open emitter |
| Emitter base voltage | V_{EBO} | | 1.2 | | Open collector |
| Base current | I_B | 3 | mA | | - |
| Collector current | I_C | 80 | | | |
| Total power dissipation ¹⁾ | P_{tot} | 185 | mW | $T_S \leq 95^\circ\text{C}$ | |
| Junction temperature | T_J | 150 | °C | - | |
| Storage temperature | T_{Stg} | | | | |

Attention: *Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the integrated circuit.*

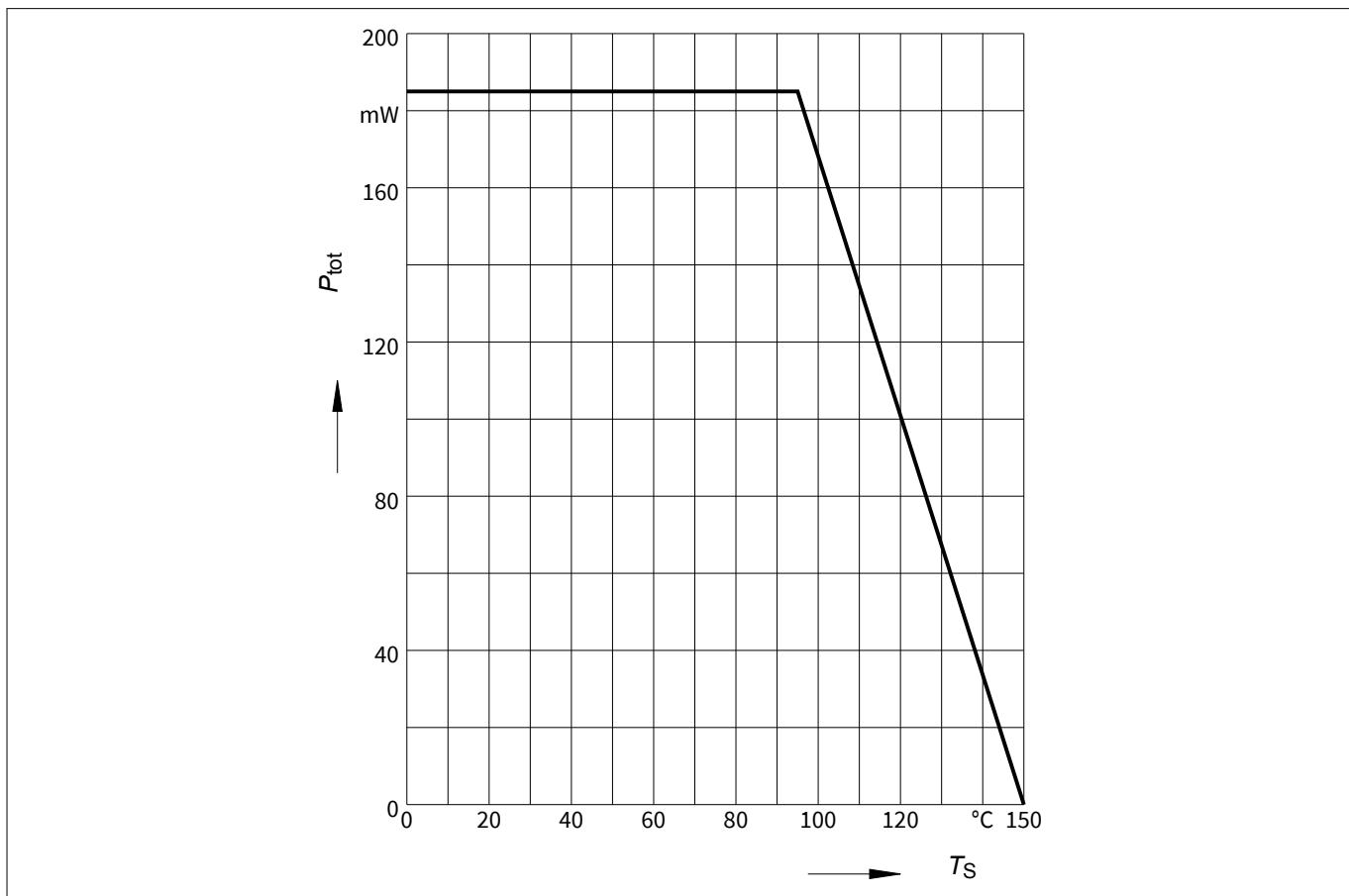
¹ T_S is the soldering point temperature. T_S is measured on the emitter lead at the soldering point of the PCB.

Thermal characteristics

2 Thermal characteristics

Table 3 Thermal resistance

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|----------------------------|-------------------|--------|------|------|------|------------------------|
| | | Min. | Typ. | Max. | | |
| Junction - soldering point | R_{thJS} | - | 300 | - | K/W | - |

**Figure 1****Total power dissipation $P_{\text{tot}} = f(T_s)$**

Thermal characteristics

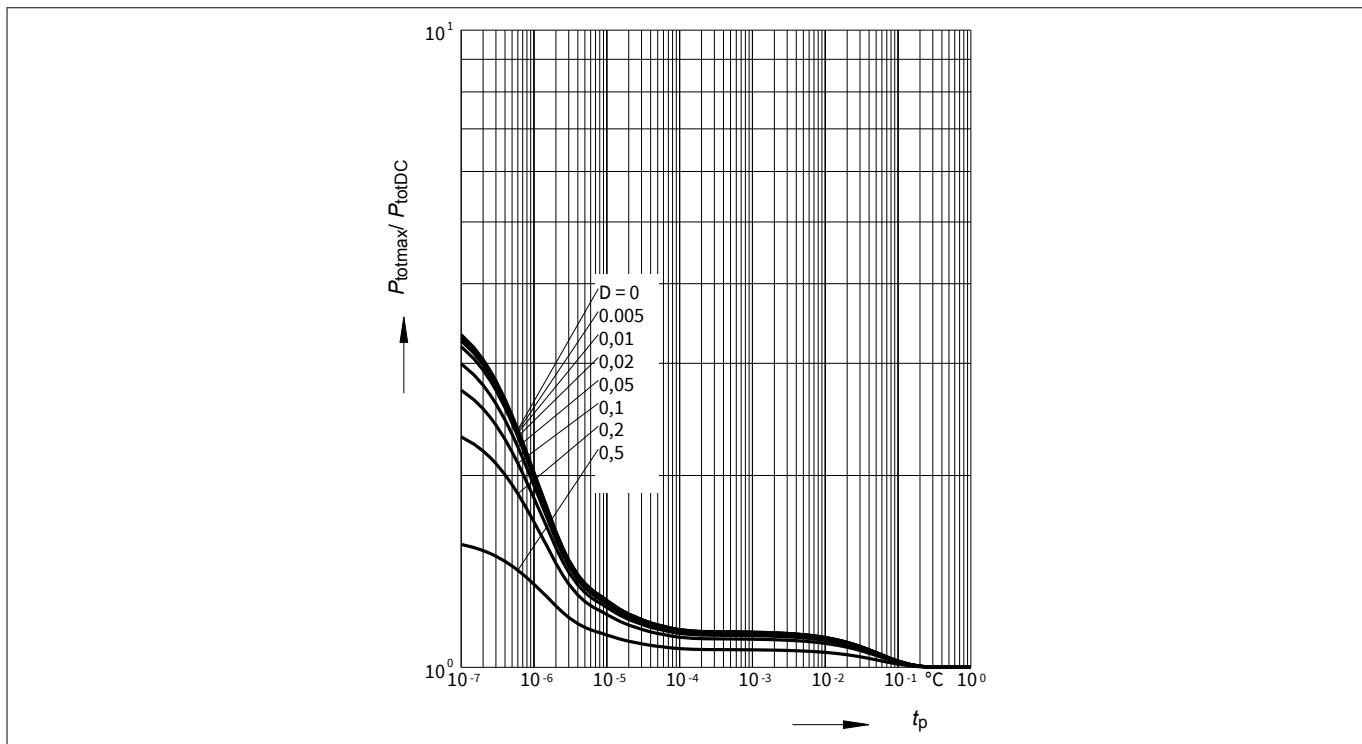


Figure 2 Permissible pulse load $P_{\text{tot},\text{max}} / P_{\text{tot},\text{DC}} = f(t_p)$

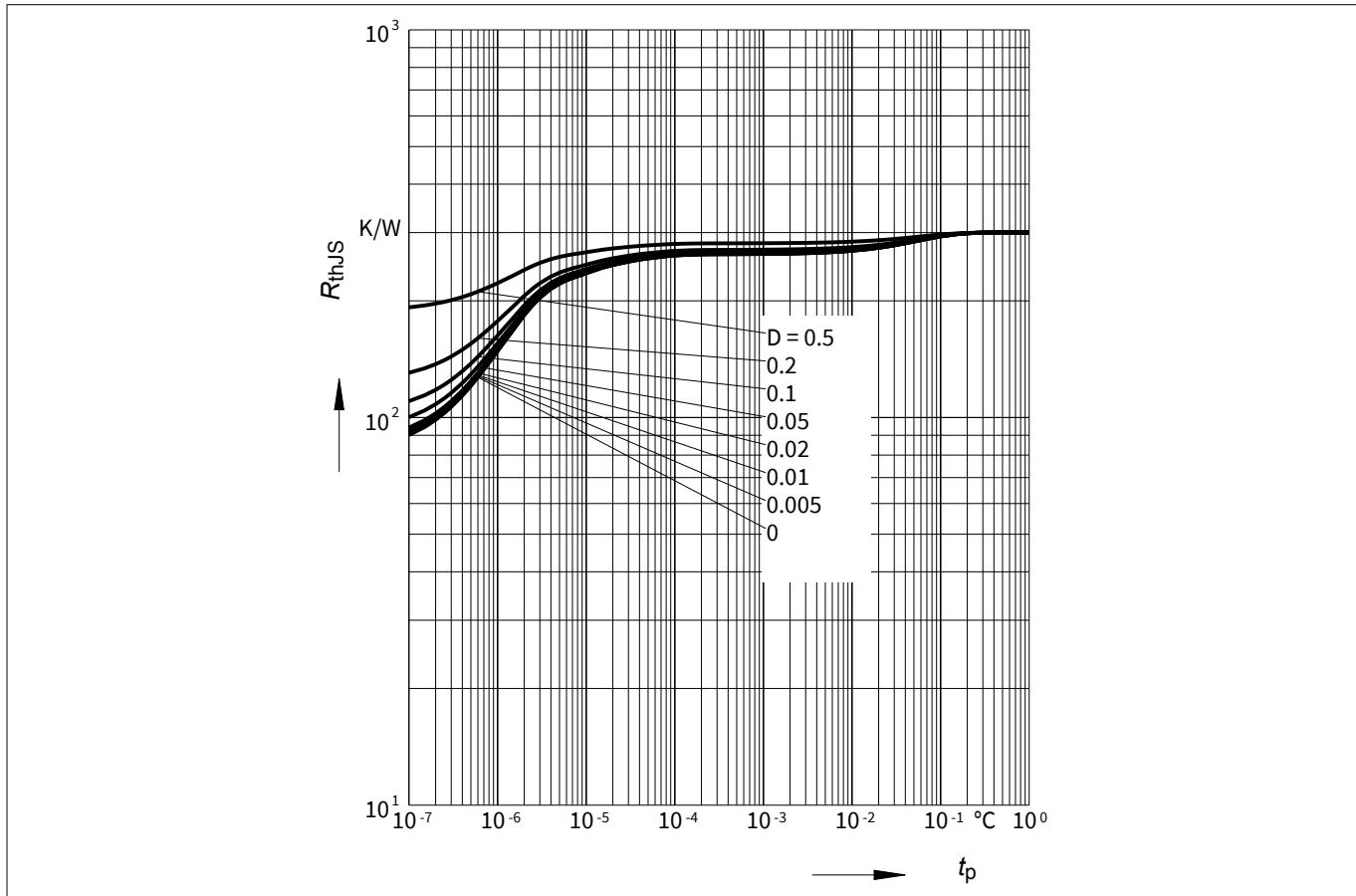


Figure 3 Permissible pulse load $R_{\text{thJS}} = f(t_p)$

Electrical characteristics

3 Electrical characteristics

3.1 DC characteristics

Table 4 DC characteristics at $T_A = 25^\circ\text{C}$

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|-------------------------------------|-----------------------------|--------|--------------|--------------------------------|---------------|--|
| | | Min. | Typ. | Max. | | |
| Collector emitter breakdown voltage | $V_{(\text{BR})\text{CEO}}$ | 2.3 | 2.8 | - | V | $I_C = 1 \text{ mA}, I_B = 0,$ open base |
| Collector emitter leakage current | I_{CES} | - | - | $10^{2)} \text{ } \mu\text{A}$ | μA | $V_{\text{CE}} = 7.5 \text{ V}, V_{\text{BE}} = 0,$ E-B short circuited |
| | | 0.001 | 0.04 $^{2)}$ | $10^{2)} \text{ } \mu\text{A}$ | | $V_{\text{CE}} = 5 \text{ V}, V_{\text{BE}} = 0,$ EB short circuited |
| Collector base leakage current | I_{CBO} | 1 | 40 $^{2)}$ | nA | nA | $V_{\text{CB}} = 5 \text{ V}, I_E = 0,$ open emitter |
| Emitter base leakage current | I_{EBO} | 10 | 900 $^{2)}$ | $10^{2)} \text{ nA}$ | | $V_{\text{EB}} = 0.5 \text{ V}, I_C = 0,$ open collector |
| DC current gain | h_{FE} | 110 | 180 | 270 | | $V_{\text{CE}} = 1.5 \text{ V}, I_C = 50 \text{ mA},$ pulse measured |

3.2 General AC characteristics

Table 5 General AC characteristics at $T_A = 25^\circ\text{C}$

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|----------------------------|-----------------|--------|------|----------------------|------|---|
| | | Min. | Typ. | Max. | | |
| Transition frequency | f_T | - | 65 | - | GHz | $V_{\text{CE}} = 1.5 \text{ V}, I_C = 50 \text{ mA},$ $f = 1 \text{ GHz}$ |
| Collector base capacitance | C_{CB} | 0.12 | 0.2 | pF | pF | $V_{\text{CB}} = 2 \text{ V}, V_{\text{BE}} = 0,$ $f = 1 \text{ MHz},$ emitter grounded |
| | | 0.22 | - | $10^{2)} \text{ pF}$ | | $V_{\text{CE}} = 2 \text{ V}, V_{\text{BE}} = 0,$ $f = 1 \text{ MHz},$ base grounded |
| Emitter base capacitance | C_{EB} | 0.46 | | | | $V_{\text{EB}} = 0.5 \text{ V}, V_{\text{CB}} = 0,$ $f = 1 \text{ MHz},$ collector grounded |

² Maximum values not limited by the device but by the short cycle time of the 100% test.

Electrical characteristics

3.3 Frequency dependent AC characteristics

Measurement setup is a test fixture with Bias-T's in a $50\ \Omega$ system, $T_A = 25\text{ }^\circ\text{C}$.

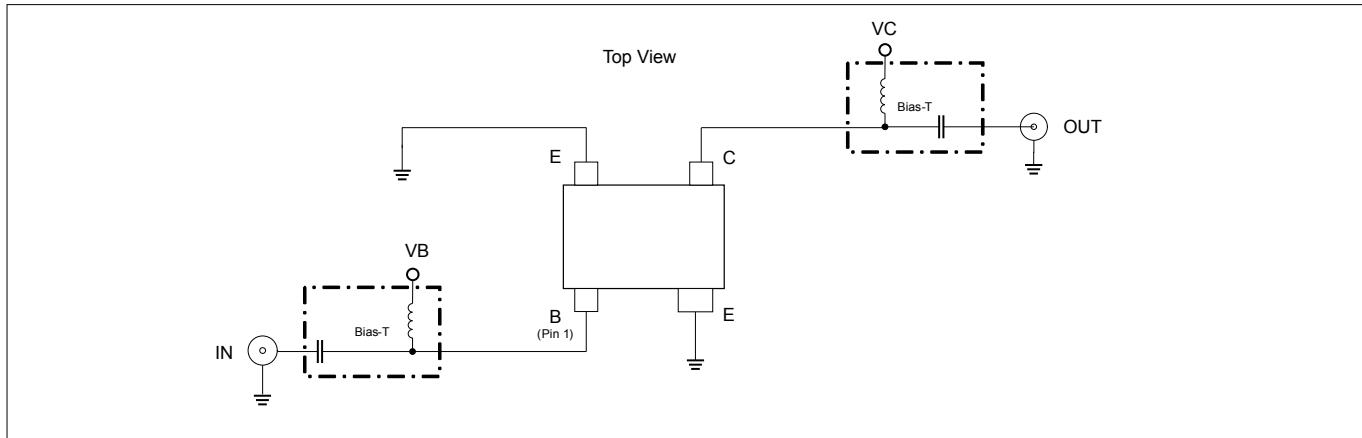


Figure 4 Testing circuit

Table 6 AC characteristics, $V_{CE} = 1.5\text{ V}$, $f = 1.8\text{ GHz}$

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|---|--------------|--------|------|------|------|---|
| | | Min. | Typ. | Max. | | |
| Power gain | | - | | - | dB | |
| • Maximum power gain | G_{ms} | 21.5 | | | | $I_C = 50\text{ mA}$ |
| • Transducer gain | $ S_{21} ^2$ | 20 | | | | |
| Noise figure | | | 0.7 | | | |
| • Minimum noise figure | NF_{min} | | | | | $I_C = 5\text{ mA}$ |
| Linearity | | | | | dBm | |
| • 3rd order intercept point at output | OIP_3 | 25.5 | | | | $I_C = 50\text{ mA}, V_{CE} = 2\text{ V}, Z_S = Z_L = 50\Omega$ |
| • 1 dB gain compression point at output | OP_{1dB} | 14.5 | | | | |

Table 7 AC characteristics, $V_{CE} = 1.5\text{ V}$, $f = 6\text{ GHz}$

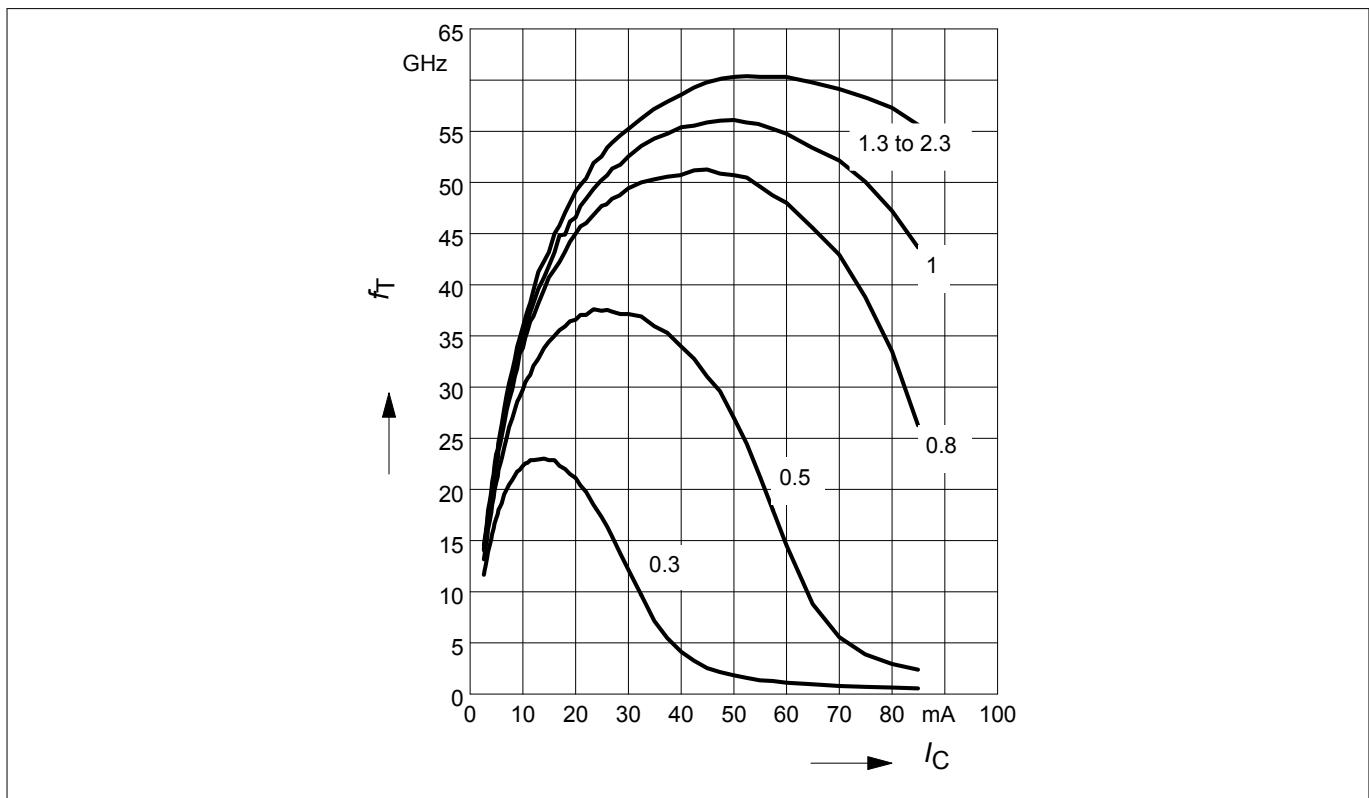
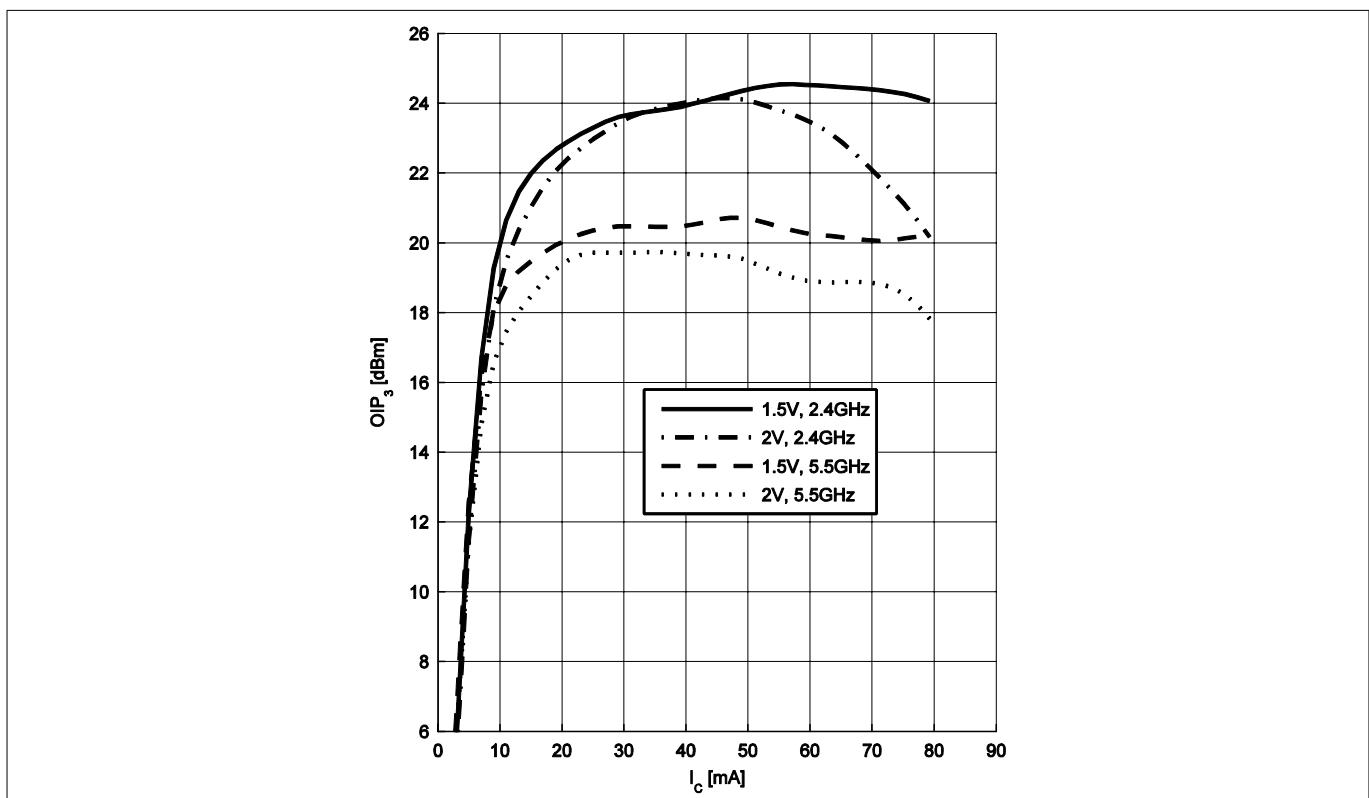
| Parameter | Symbol | Values | | | Unit | Note or test condition |
|------------------------|--------------|--------|------|------|------|------------------------|
| | | Min. | Typ. | Max. | | |
| Power gain | | - | | - | dB | |
| • Maximum power gain | G_{ms} | 11 | | | | $I_C = 50\text{ mA}$ |
| • Transducer gain | $ S_{21} ^2$ | 9.5 | | | | |
| Noise figure | | | 1.3 | | | |
| • Minimum noise figure | NF_{min} | | | | | $I_C = 5\text{ mA}$ |

Note: $G_{ms} = |S_{21}| / S_{12}|$ for $k < 1$; $G_{ma} = |S_{21}| / S_{12}| / (k - (k^2 - 1)^{1/2})$ for $k > 1$. In order to get the NF_{min} values stated in this chapter, the test fixture losses have been subtracted from all measured results. OIP_3 value depends on termination of all intermodulation frequency components. Termination used for this measurement is 50Ω from 0.1 MHz to 6 GHz .

Electrical characteristics

3.4

Characteristic AC diagrams

Figure 5 Transition frequency $f_T = f(I_C)$, $f = 1 \text{ GHz}$, $V_{CE} = \text{parameter}$ Figure 6 3rd order intercept point $OIP_3 = f(I_C)$, $Z_S = Z_L = 50 \Omega$, V_{CE} , f = parameters

Electrical characteristics

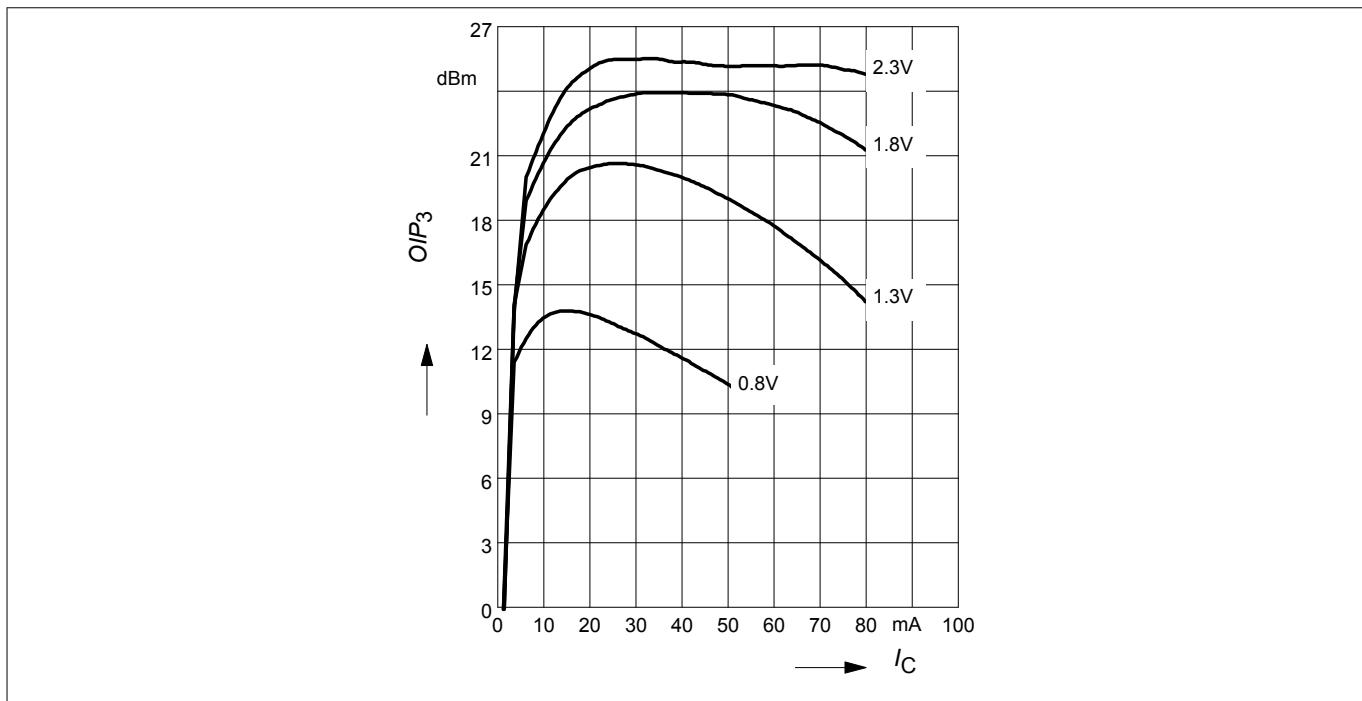


Figure 7 3rd order intercept point at output $O/I P_3 = f(I_C, V_{CE})$, $Z_S = Z_L = 50 \Omega$, $f = 900 \text{ MHz}$

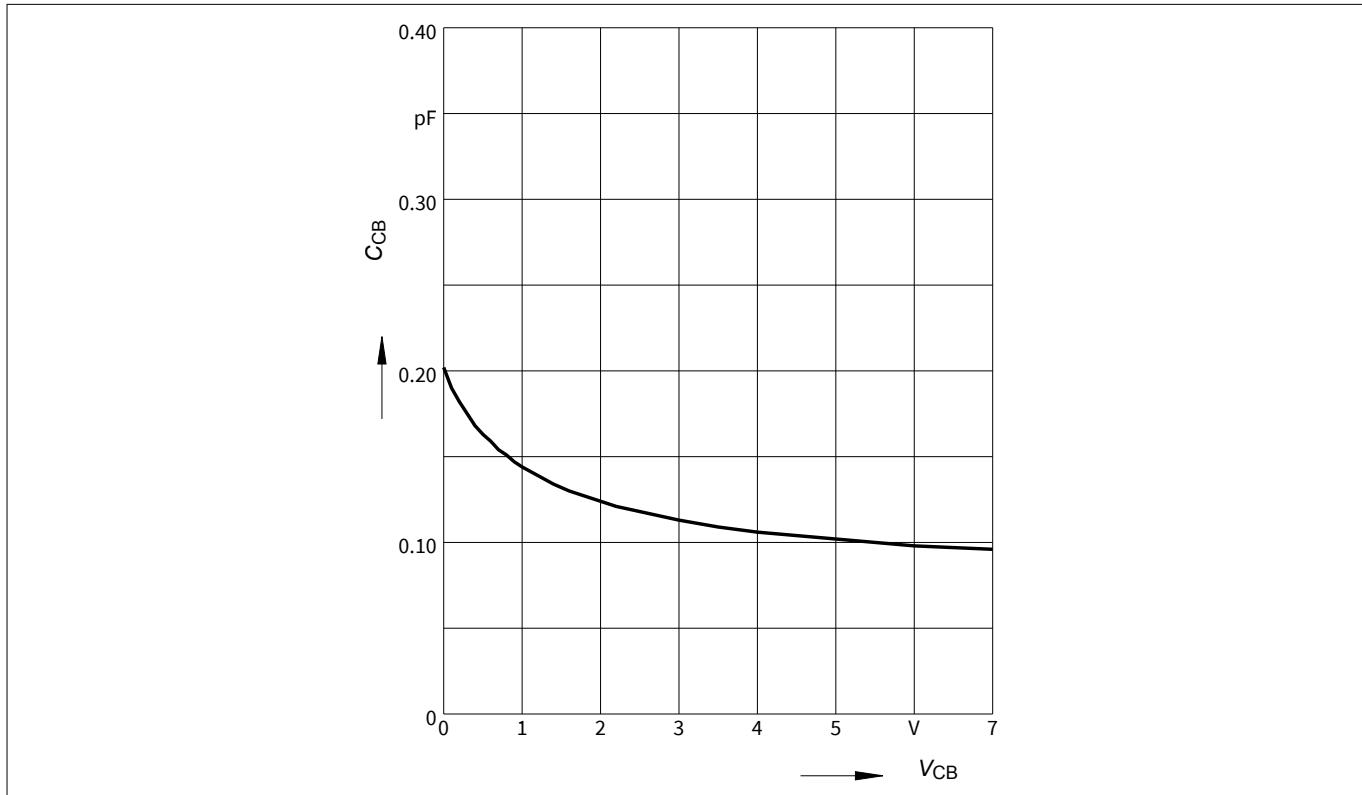


Figure 8 Collector base capacitance $C_{CB} = f(V_{CB})$, $f = 1 \text{ MHz}$

Electrical characteristics

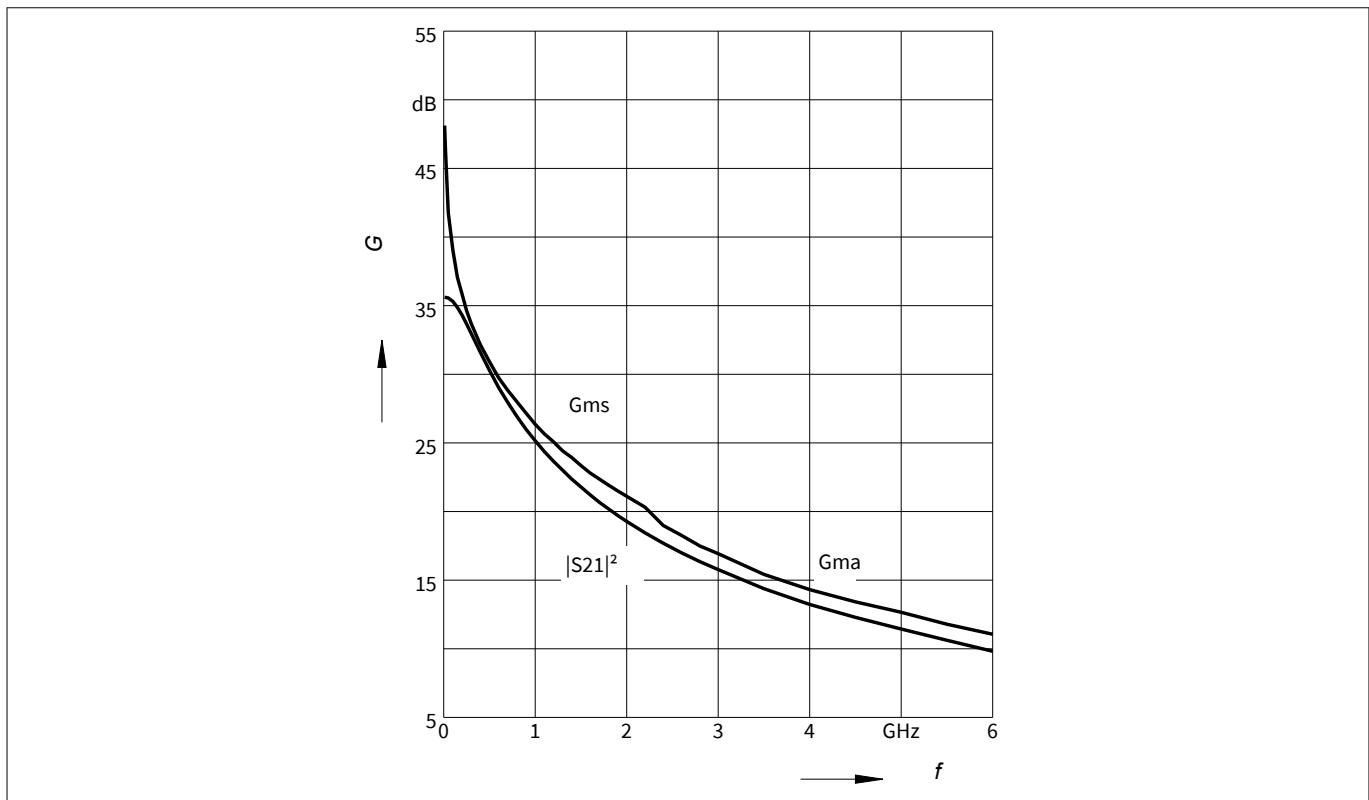


Figure 9 Gain G_{ma} , G_{ms} , $|S_{21}|^2 = f(f)$, $V_{CE} = 1.5$ V, $I_C = 50$ mA

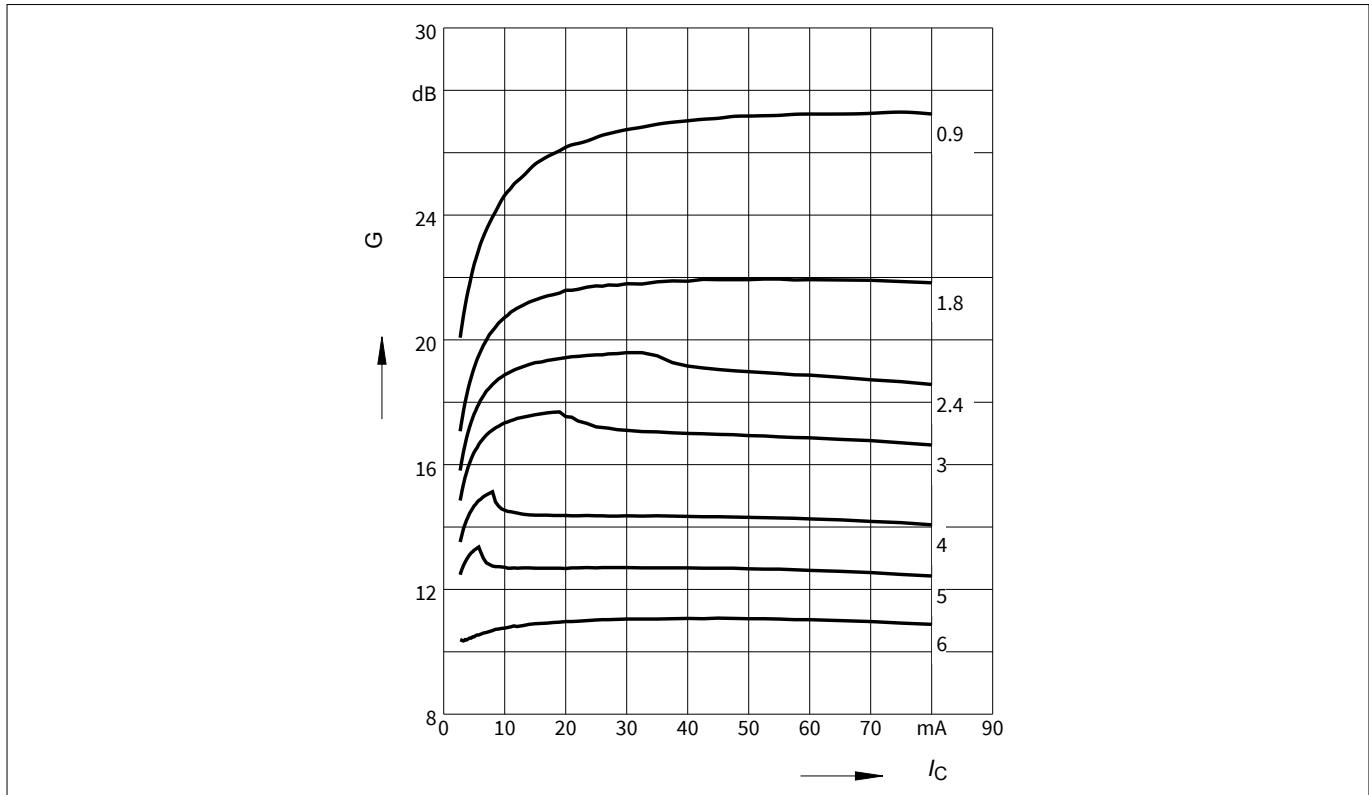
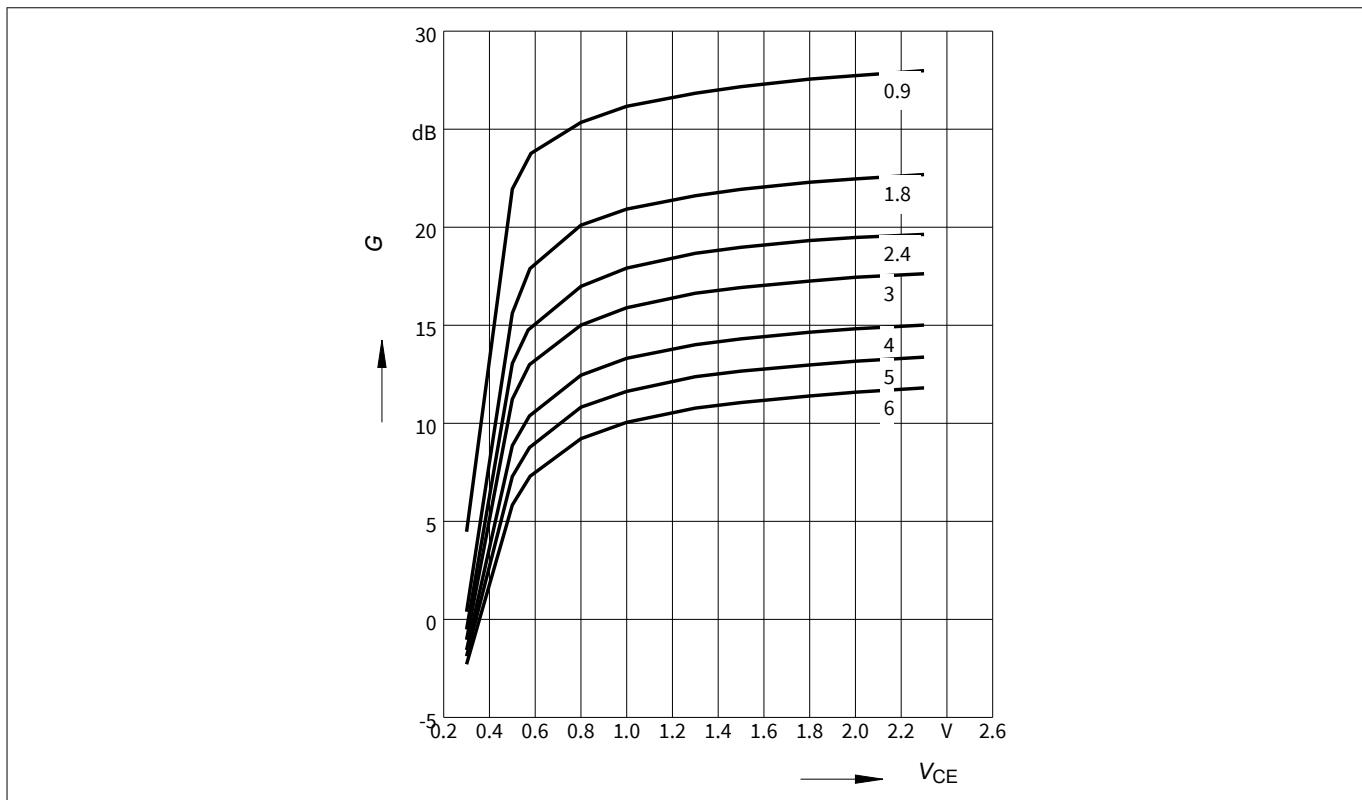
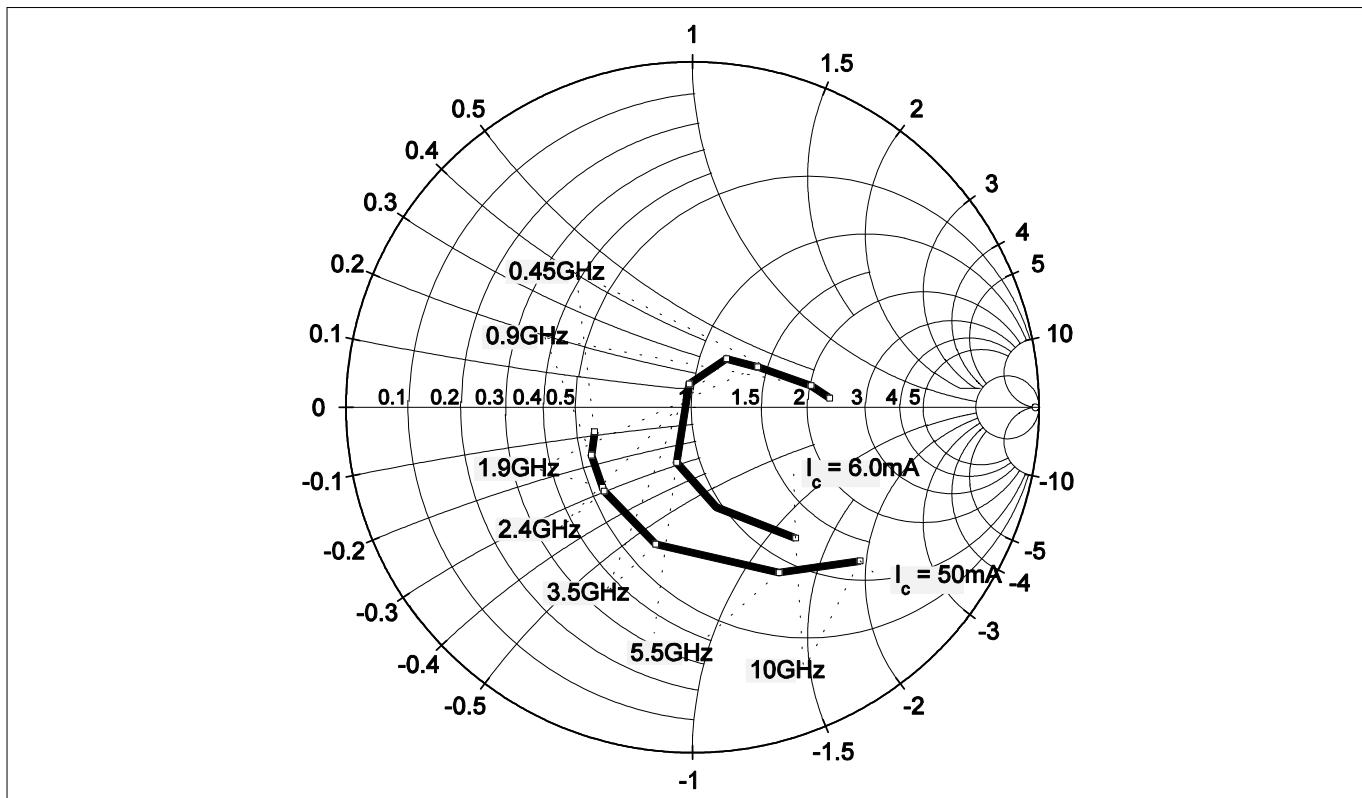


Figure 10 Maximum power gain $G_{max} = f(I_C)$, $V_{CE} = 1.5$ V, f = parameter in GHz

Electrical characteristics

Figure 11 Maximum power gain $G_{\max} = f(V_{CE})$, $I_C = 50 \text{ mA}$, $f = \text{parameter in GHz}$ Figure 12 Source impedance for minimum noise figure $Z_{S,\text{opt}} = f(f)$, $V_{CE} = 3 \text{ V}$, $I_C = 6 / 50 \text{ mA}$

Electrical characteristics

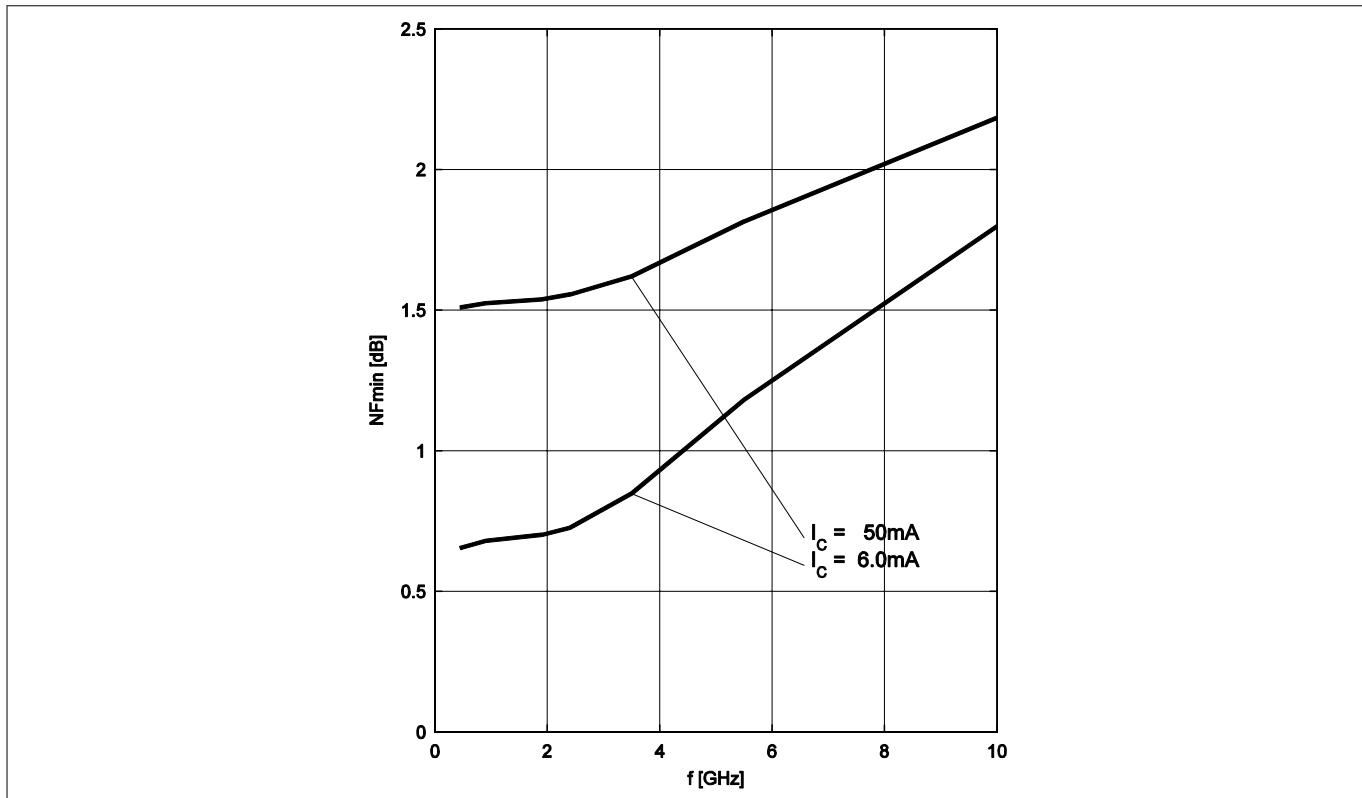


Figure 13 Noise figure $NF_{min} = f(f)$, $V_{CE} = 2\text{ V}$, $Z_S = Z_{S,opt}$, $I_C = 6 / 50\text{ mA}$

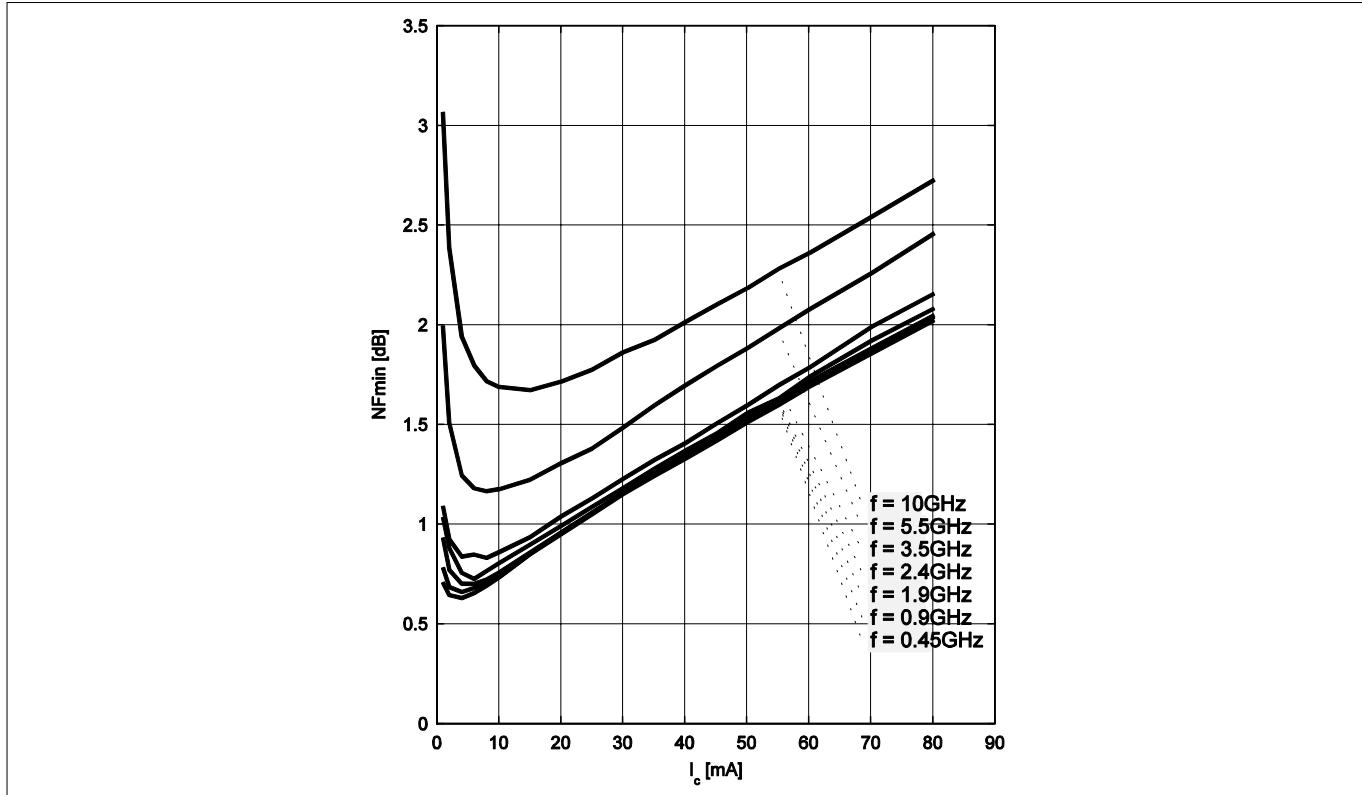


Figure 14 Noise figure $NF_{min} = f(I_C)$, $V_{CE} = 2\text{ V}$, $Z_S = Z_{S,opt}$, f = parameter in GHz

Note: The curves shown in this chapter have been generated using typical devices but shall not be considered as a guarantee that all devices have identical characteristic curves. $T_A = 25^\circ\text{C}$.

Package information SOT343

4

Package information SOT343

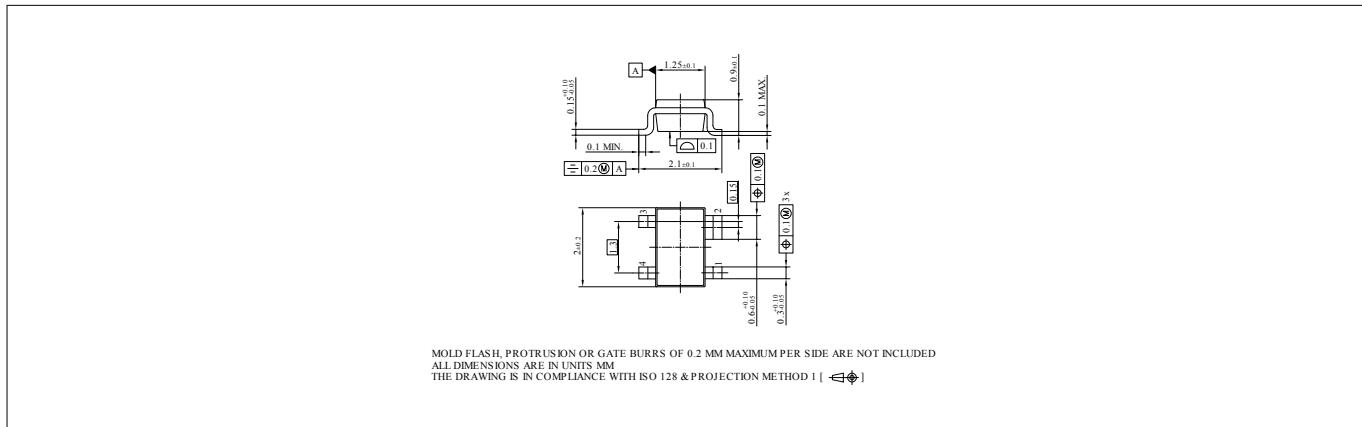


Figure 15 Package outline

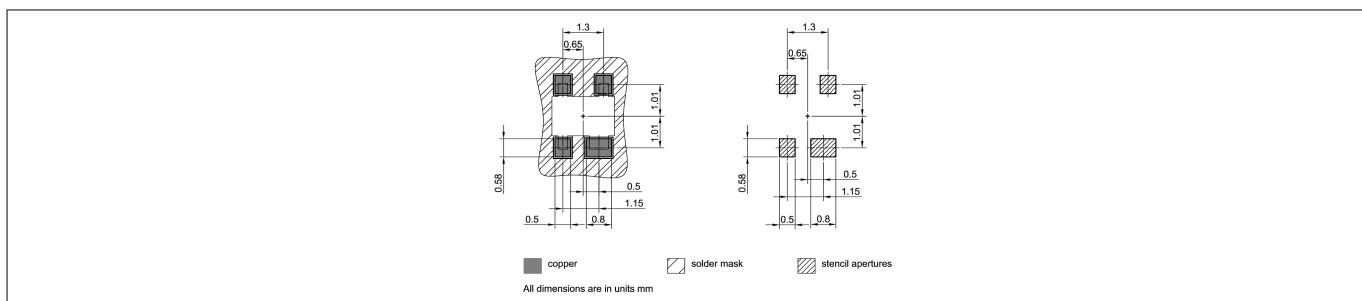


Figure 16 Foot print

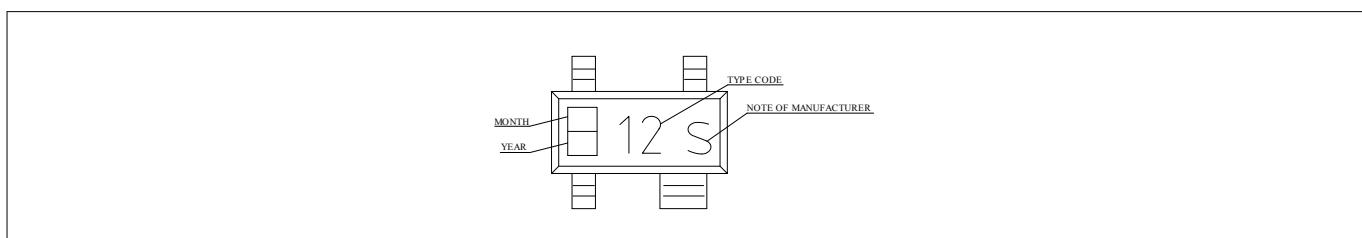


Figure 17 Marking layout example

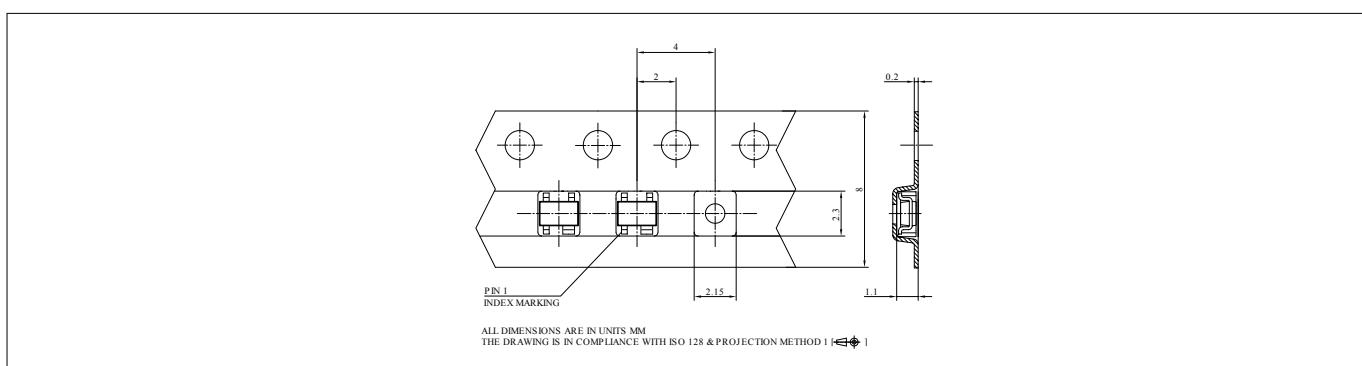


Figure 18 Tape dimensions

Revision history**Revision history**

| Document version | Date of release | Description of changes |
|-------------------------|------------------------|-------------------------------|
| Revision 2.0 | 2019-01-25 | New datasheet layout. |

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

Edition 2019-01-25

Published by

**Infineon Technologies AG
81726 Munich, Germany**

**© 2019 Infineon Technologies AG
All Rights Reserved.**

Do you have a question about any aspect of this document?

Email: erratum@infineon.com

**Document reference
IFX-ebp1526288323555**

IMPORTANT NOTICE

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

WARNINGS

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury